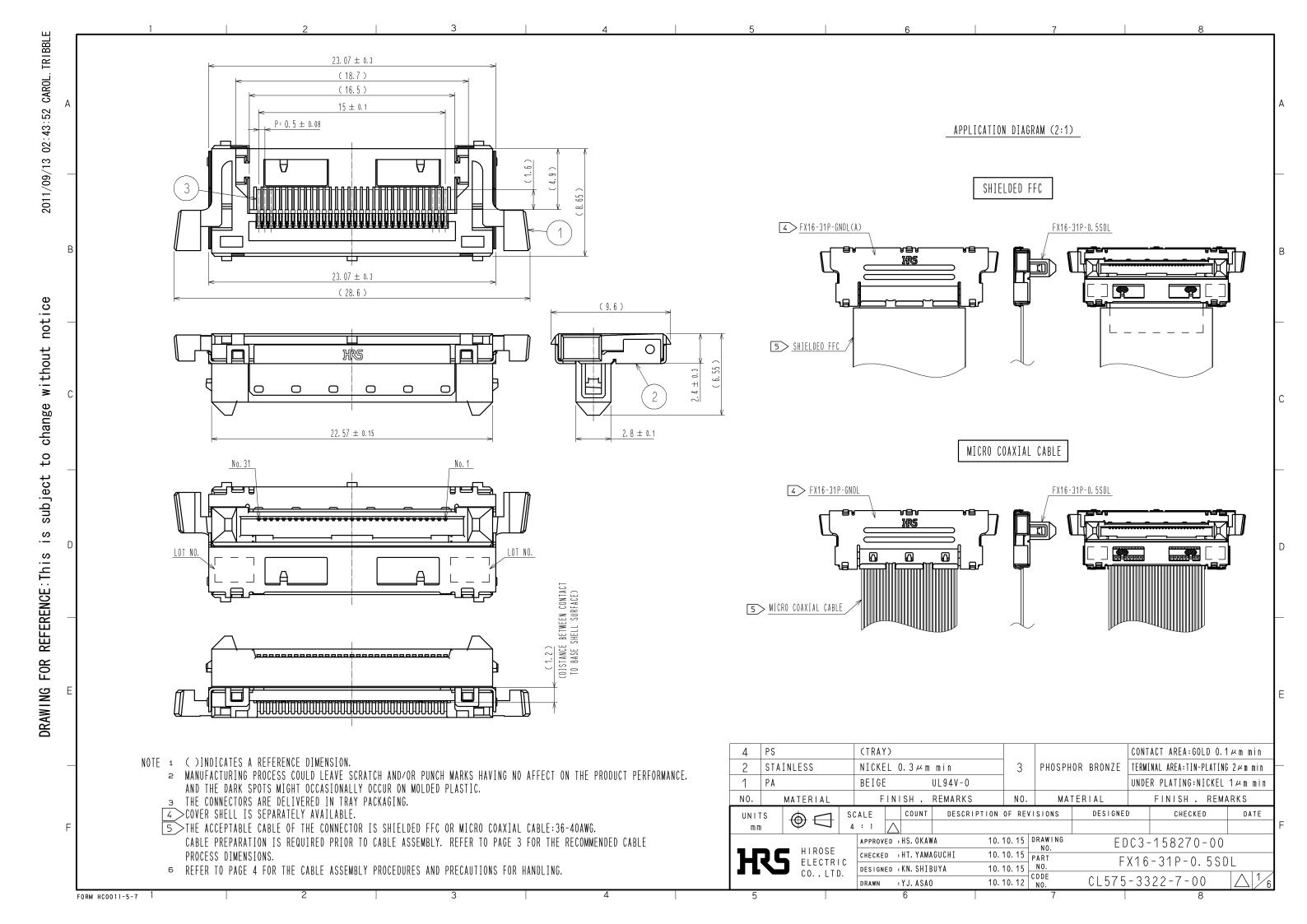
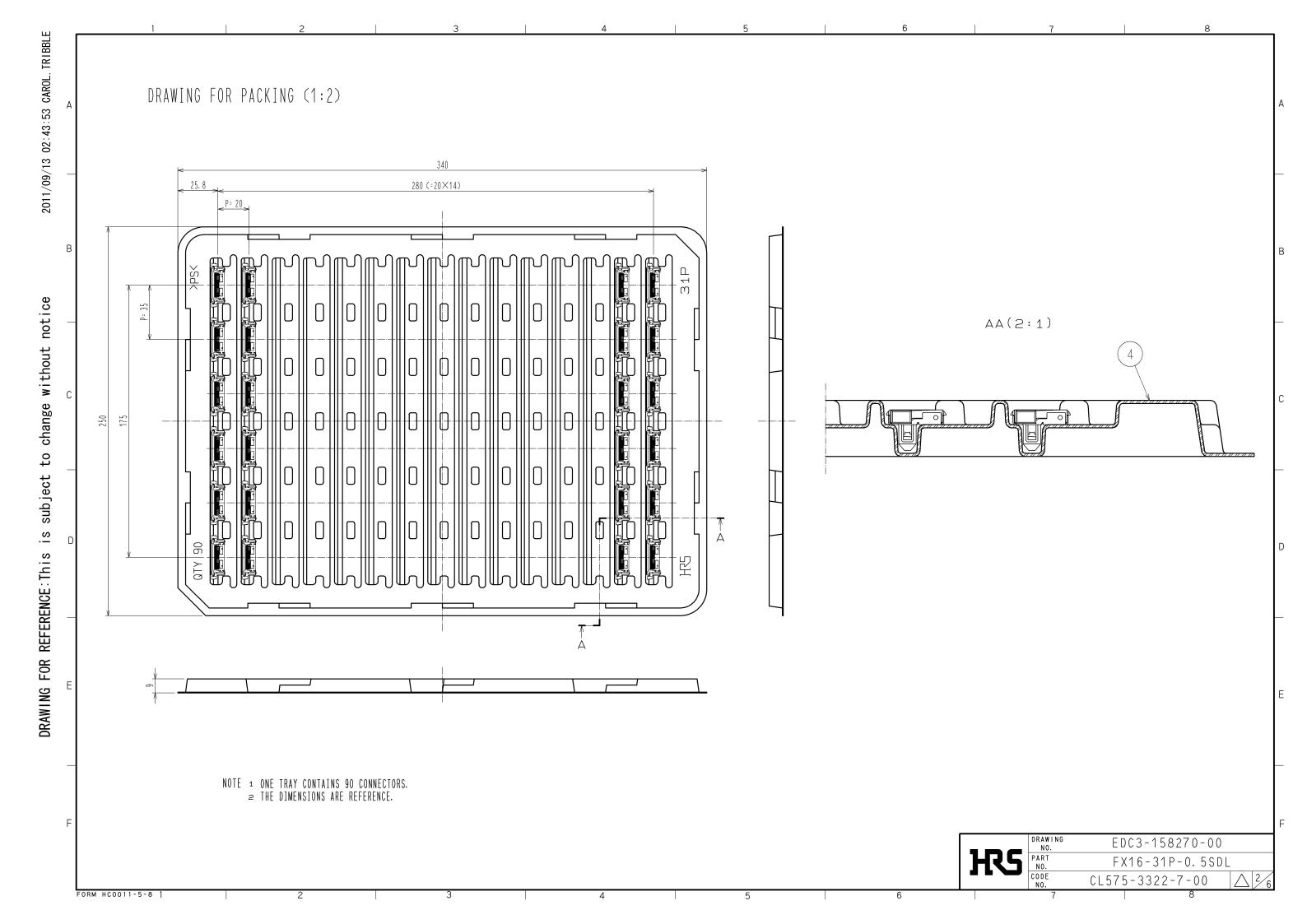
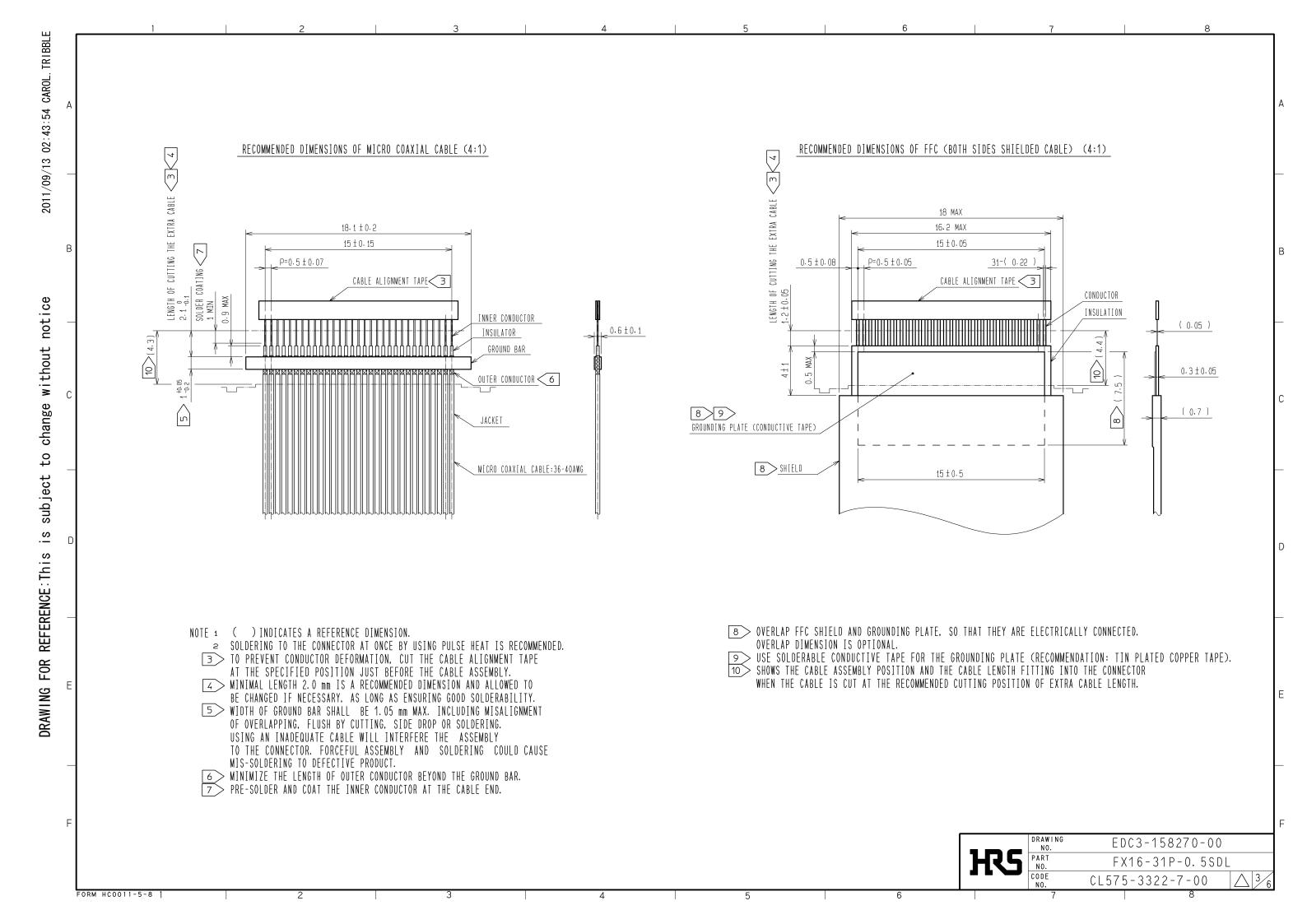
APPLICAE	BLE STAN	DARD							
<b>A</b>	OPERATING	DE DANCE	55 °C TO 85 °C	C (1) (2)	STORAGE	DE DANCE	-10 °C TO 60 °C	(3)	
A RATING	TEMPERATURE RANGE		OPI		TEMPERATU OPERATING RANGE		RH 85 % MAX		
NATING	VOLTAGE				STORAGE H	YTIDIMU			
	CURRENT		0.5 A <sup>(5)</sup> RANGE RH 70 % MAX					(3) (4)	
	APPLICABLE	CABLE	AWG 36,40 THIN COAXIAL CABLE / FFC (6)						
				IFICAT	IONS			I	
	EM		TEST METHOD			REQU	IREMENTS	QT	Α
CONSTRU GENERAL EXA		TVISLIALIN	AND BY MEASURING INSTRU	IMENIT	IACCORE	DING TO DRAV	MING	l ×	Ι;
MARKING	AMINATION		MED VISUALLY.			DING TO DICA	WING.	×	+ ;
ELECTRIC	CHARAC	TERISTI	CS					_	
CONTACT RES		20 mV MA	X, 1 mA(DC OR 1000Hz)			80n	1Ω MAX. <sup>(7)</sup>	×	
INSULATION F	RESISTANCE	100 V DC.				500 MΩ MIN.			
VOLTAGE PRO	OOF	200 V AC	FOR 1 min. NO FLASHOVER OR BREAKDOWN				REAKDOWN.	×	
MECHANI	CAL CHAR	ACTERI	STICS		•			•	
INSERTION AN WITHDRAWAL		MEASURE	ED BY APPLICABLE CONNECT	OR.			15.5 N MAX. E: 1.55 N MIN.	×	
MECHANICAL	OPERATION	50 TIMES	INSERTIONS AND EXTRACTION	ONS.	20 mg ② NO D	ONTACT RESISTANCE: NO VARIATION OF  D MΩ OR MORE FROM INITIAL VALUE.  D DAMAGE, CRACK AND LOOSENESS OF  ARTS.			
SINGL AM			ICY 10 TO 55 Hz, IPLITUDE : 0.75 mm, FOR 3 DIRECTION.		② NO D		ISCONTINUITY OF 1 µs. X		
SHOCK		1	, DURATION OF PULSE 11 TIMES FOR 3 DIRECTIONS					×	
OCK STRENG	GTH	мате то	APPLICABLE CONNECTOR AND APPLY CE HORIZONTALLY.  30 N MIN.				×		
ENVIRONI	MENTAL C	HARAC	TERISTICS		•				
DAMP HEAT		EXPOSED	AT 40±2°C, 90 ~ 95 %,	96 h.	_	FACT RESISTA		×	
(STEADY STA <sup>-</sup> DRY HEAT	ΓE)	EVDOSED	AT 85±2°C, 96 h			'ARIATION OF VI INITIAL VAL	OF 20 mΩ OR MORE		
RAPID CHANG		TEMPERA	TURE -55→+5~+35→+85→+	$5 \rightarrow +5 \sim +35 \rightarrow +85 \rightarrow +5 \sim +35$ °C ② INSULATION RESISTANCE: 500 MΩ MIN.					
TEMPERATURE		TIME UNDER	$30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ M}$ 5 CYCLES.	MAX min.	PART		CK AND LOOSENESS OF		
CORROSION			IN 5 % SALT WATER SPRAY F	OR 48 h.		CONTACT RESISTANCE:NO VARIATION OF			
SULFUR DIOX	IDE	1	D IN 25 PPM FOR 96 h. $20 \text{ m}\Omega$ OR MORE FROM INITIAL VALUE. ANDARD: JIS C 60068)					×	
SOLDERING HEAT PRE (CO (FFC			28 28 XS  RING IRONS: 360°C MAX. FOR	sec	LOOSEN	ORMATION OI	F CASE OF EXCESSIVE TERMINAL.	×	
SOLDERABILITY		+ '	D AT SOLDER TEMPERATURE		A NEW U	JNIFORM COA	ATING OF SOLDER SHALL	×	+
		1	C FOR IMMERSION DURATION, 3 sec.			COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			
COUN	T D	ESCRIPTI	ON OF REVISIONS		ESIGNED		CHECKED	DA	ΛTΕ
<u>^2</u> 2		DIS	-F-004353	K	(N. SHIBUYA		HT. YAMAGUCHI	09. 1	2.
(2) OPERATING		IPERATURE SH	RISE CAUSED BY CURRENT-CARRYING. IE SHOULD BE -55 TO 40°C WHEN HUMIDITY EXCEEDS 80% RH. PLIED TO THE PRE-ASSEMBLED COMPONENT AND THE CABLE			APPROVED		08.0	
	ASSEMBLED PRO (4) THERE MUST NO	ODUCT BOTH IN T BE DEWFALL	OTH IN DELIVERY AND STORAGE, BEFORE ASSEMBLED TO PCB: VFALL.			CHECKED	HT. YAMAGUCHI	08.0	
(5) IT IS THE MAXIMUM VALUE OF CONNECTOR. CONFIRM THE SPECIFICATION (6) ONLY FFC THAT PROCESSES THE TERMINAL THAT WE SPECIFIED. (7) DON'T INCLUDE CONDUCTOR RESISTANCE OF CABLE.  Unless otherwise specified, refer to JIS-C-5402.			E TERMINAL THAT WE SPECIFIED.	LE.	DESIGNED	TS. SHIBUYA	08.0		
					DRAWN	TS. SHIBUYA	08.0	)5.	
Note QT:Qu	alification Tes	t AT:Assı	urance Test X:Applicable Tes	st	DRAWIN	G NO.	ELC4-158270		
HS.			CATION SHEET	F	PART NO.		FX16-31P-0. 5SDL	, 1	
	HIR	ROSE EI	LECTRIC CO., LTD.	C	ODE NO.	CL57	5-3322-7-00	<u> </u>	1/







Cautions for soldering

1. Recommended solder

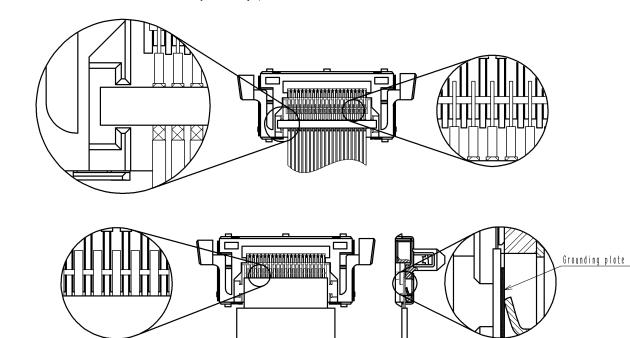
Flux cored solder (Lead-free: Sn-3Ag-0.5Cu)

Micro coaxial cable · · · 0.15 mm dia. Length 15.5 mm --- 0.1 mm dia, Length 15.5 mm

If you consider using additional flux, please pay enough attention not to have flux wicking to the contact area. Flux wicking to the contact area will cause contact failure.

2. Setting the cable

Set the conductors as each conductor is placed at the center of the contact. In case of micro cooxial cable, set it as the metal bar fits in the guide on the connector. In case of FFC, set it as the grounding plate side faces to the connector.

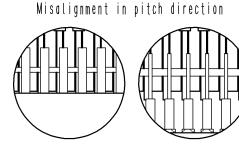


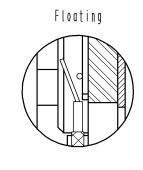
- 3. Place the cable to the connector and check the below points before soldering by pulse heat.
  - Transformation of conductor
  - · Misalignment of conductor to the terminals in pitch direction
  - Excessive floating of conductor

The above could cause soldering failure and/or solder bridge.

Transformation of conductor



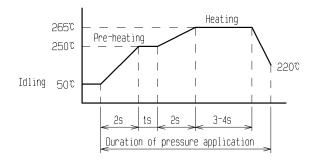




4. Follow the recommended temperature profile shown below for the soldering.

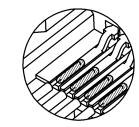
The optimum condition could vary depending on various factors including type of cable and its length, solder type. Therefore refer to the recommended temperature profile and optimize the condition if necessary.

heating		Micro coaxial cable	FFC
	Temperature (Y)	275± 5 ℃	265± 5 ℃
	Duration (X)	2± 0.5 sec	2.5± 0.5 sec



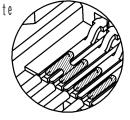
5. After soldering, check that no defect is found at soldered area. Examples of correct soldered and defective soldered state are shown below.

Correct soldering

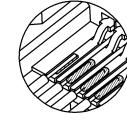


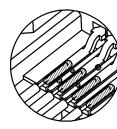
Conductors are placed at the center of the contact, and whole area is equally wetted.

Defective soldered state



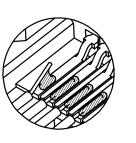
Solder bridge

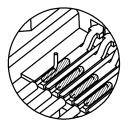


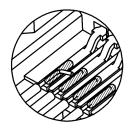


Solder shortage

Solder ball dispersion







Floating

Conductor sticking out The conductor approaches

to the adjacent contact

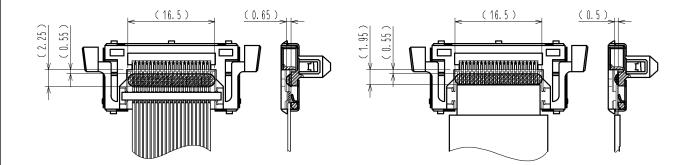
\*Note: The figures shown in this page are solely for the instruction purpose. Therefore the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

]	HS.	DRAWING NO.	EDC3-158270-00		
		PART NO.	FX16-31P-0.5SDL		
		CODE NO.	CL575-3322-7-00	$\triangle$	4/
		7	Ō		

# F

Cautions for potting process

- 1. Protect the soldered area by UV cured resin or any equivalent (referred to as 'potting' hereafter). In order to prevent insulating failure caused by metal adhering, cable breakage during cabling and other troubles.
- 2. Apply 3033 manufactured by THREEBOND CO., LTD. or any equivalent product for potting. Follow the instruction of potting manufacture's for the condition of UV exposure.
- 3. Refer to the following conditions for the potting area.



4. Use extreme care for the handling after soldering to the end of potting process not to apply stress to the cable, otherwise, cable could be broken.

Exercise extreme caution during the process so that no resin flows or adheres to the contact area.

# Cautions for cover shell assembly

1. Attach a cover shell separately provided after the cable assembly process.

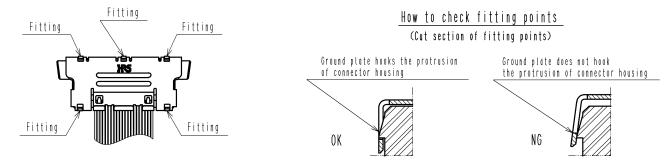
For micro coaxial cabla : FX16-31P-GNDL
For FFC : FX16-31P-GNDL(A)

Cover shell

FORM HC0011-5-8

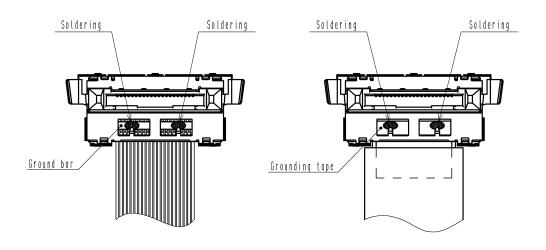
2. Place the cover shell onto the connector horizontally and pinch two components from top and bottom with fingers.

3. Check the five fitting points after assembly and make sure that they are all correctly fitted together.



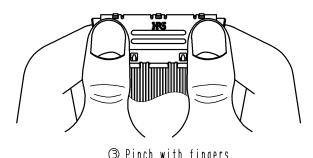
# Soldering to ground plate

1. Solder down the metal bar of the cable and ground plate after the assembly of ground plate in order to enhance the grounding performance and robustness against cable stroke to up and down direction.



2. Excess solder and/or excess heating could cause cable and connector deformation and/or melt.

Cable assembly process is completed.



\*Note: The figures shown in this page are solely for the instruction purpose. Therefore, the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

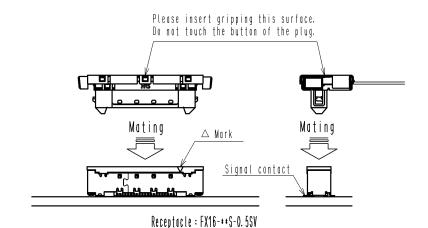
	KS	DRAWING NO.	EDC3-158270-00		
H		PART NO.	FX16-31P-0.5SDL		
		CODE NO.	CL575-3322-7-00	$\triangle$	5/6
		7	Q		

① Prepare the cover shell ② Horizontally ③ Pinch with fingers from the top

Handling instructions

#### 1. Insertion to on-board connector

The connector mating is keyed. Align the marks as shown in the figure for mating. Insert the connector complétely until they are locked at both ends.



The connectors have a reverse-insertion prevention structure, however, the connectors may be damaged when inserted reversely with the force of 25 N or more. Avoid a forceful insertion, and make sure to confirm that the connectors are aligned with the marks before the mating operation.

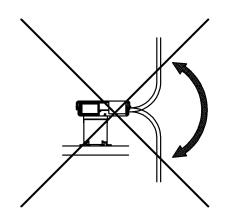
### 2. After mating

FORM HC0011-5-8

Carefully wire cables, so that excessive force will not be applied to the mated connectors. Pulling the cable with the force of 20 N or more may damage the connectors. It may also cause cable breakage. Take a caution to avoid pulling the cables.

Repetitive cable strokes could also cause cable breakage as well. Do not use the connector under the environment of repetitive cable strokes.

Take enough bend radius and/or distance from the connector for the cable not to apply stress to the connector base when the application requires cable bend back.



Take long distance from the connector body

Take large radius

Repetitive cable strokes

Application of cable bend back

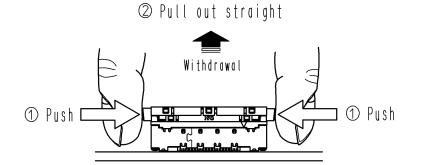
\*Note: The connectors shown in this page are drawn for the instruction purpose, therefore, the appearance differs from the actual connectors.

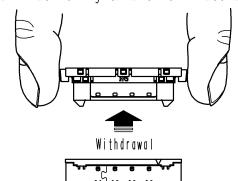
#### 3. Withdrawal from on-board connector

The connectors are locked while they are mated. In order to unmate the connectors, pull out straight, with the button pushed to release the lock. At this time, do not pull the cable. Also, avoid the withdrawal in angle, which may damage the connectors.

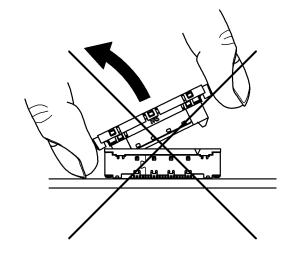
# <Correct withdrawal>

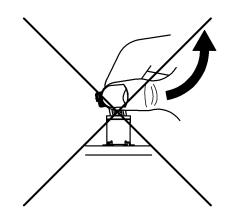
3 Pull out straight, with the button pushed.

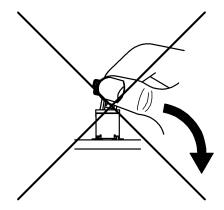




# <Incorrect withdrawal>







HS.	DRAWING NO.	EDC3-158270-00		
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	CODE NO.	CL575-3322-7-00	$\bigcirc$	6

Please confirm the connector configuration on the connector drawing (SHEET 1).